





#### PNP SILICON PLANAR MEDIUM POWER HIGH GAIN TRANSISTOR

### **Features**

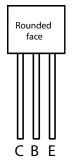
- 200 Volt V<sub>CEO</sub>
- Gain of 250 at IC=0.3 Amps •
- Very low saturation voltage •

# **Mechanical Data**

Case: E-Line •



Bottom View



Pin Configuration

### **Maximum Ratings**

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V <sub>CBO</sub>	-200	V	
Collector-Emitter Voltage	V <sub>CEO</sub>	-200	V	
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V	
Peak Pulse Current	I <sub>CM</sub>	-1	A	
Continuous Collector Current	Ic	-0.5	А	

E-Line **TO92** Compatible

## **Thermal Characteristics**

Charac	teristic	Symbol	Value	Unit	
Practical Power Dissipation (Note 1)		P <sub>totp</sub>	1.5	W	
Power Dissipation T <sub>A</sub> = 25°C Derate above 25°C		P <sub>tot</sub>	1 5.7	W mW /°C	
Thermal Resistance Junction to	Ambient <sub>1</sub> (Note 2)	$R_{\theta JA1}$	175	°C/W	
Thermal Resistance Junction to Ambient <sub>2</sub> (Note 2)		$R_{\theta JA2}$	116	°C/W	
Thermal Resistance Junction to Case		$R_{ ext{ heta}JC}$	70	°C/W	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +200	°C	

1. The power which can be dissipated assuming the device is mounted in a typical manner on a P.C.B. with copper equal to 1 inch square minimum Notes: 2. Device mounted on P.C.B. with copper equal to 1 sq. Inch minimum.





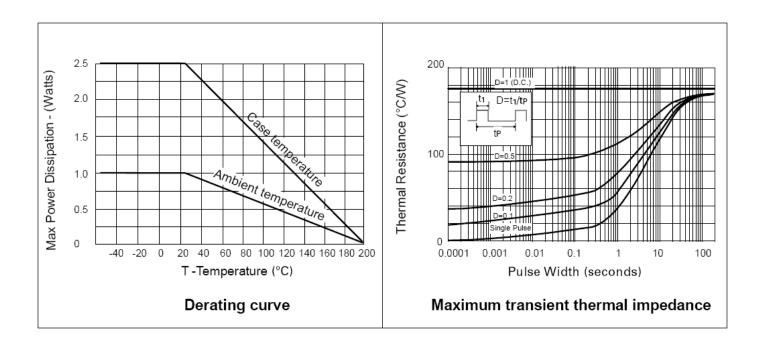
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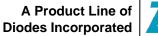
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## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-200	-	-	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 3)	V <sub>(BR)CEO</sub>	-200	-	-	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5	-	-	V	I <sub>E</sub> = -100μA
Collector Cutoff Current	I <sub>CBO</sub>	-	-	-0.1	μA	V <sub>CB</sub> = -150V
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	-0.1	. μA	$V_{EB} = -4V$
Collector-Emitter Saturation Voltage (Note 3)	V <sub>CE(sat)</sub>	-	-	-0.2 -0.3 -0.3	mV mV mV	$I_{C} = -50$ mA, $I_{B} = -2$ mA $I_{C} = -100$ mA, $I_{B} = -5$ mA $I_{C} = -200$ mA, $I_{B} = -20$ mA
Base-Emitter Saturation Voltage (Note 3)	V <sub>BE(sat)</sub>	-	-	-0.95	mV	I <sub>C</sub> = -200mA, I <sub>B</sub> = -20mA
Base-Emitter Turn-On Voltage (Note 3)	V <sub>BE(on)</sub>	-	-0.67		mV	$I_{C} = -200 \text{mA}, V_{CE} = -10 \text{V}$
Static Forward Current Transfer Ratio (Note 3)	hfe	300 300 250 100	-	800		$\begin{split} I_{C} &= -10 \text{mA}, \ V_{CE} &= -5 \text{V} \\ I_{C} &= -1 \text{A}, \ V_{CE} &= -5 \text{V} \\ I_{C} &= -2 \text{A}, \ V_{CE} &= -5 \text{V} \\ I_{C} &= -5 \text{A}, \ V_{CE} &= -5 \text{V} \end{split}$
Transition Frequency	fт	100	-	-	MHz	V <sub>CE</sub> = -5V, I <sub>C</sub> = -50mA f = 50MHz
Input Capacitance	C <sub>ibo</sub>	-	225	-	pF	V <sub>EB</sub> = -0.5V. f = 1MHz
Output Capacitance	C <sub>obo</sub>	-	12	-	pF	$V_{CB} = -10V. f = 1MHz$
Switching Times	t <sub>on</sub> t <sub>off</sub>		100 3200	-	ns ns	$V_{CC} = -50V, I_C = -100mA$ $I_{B1} = -I_{B2} = -10mA$

Notes: 3. Measured under pulsed conditions. Pulse width = 300  $\mu$ s. Duty cycle  $\leq 2\%$ 

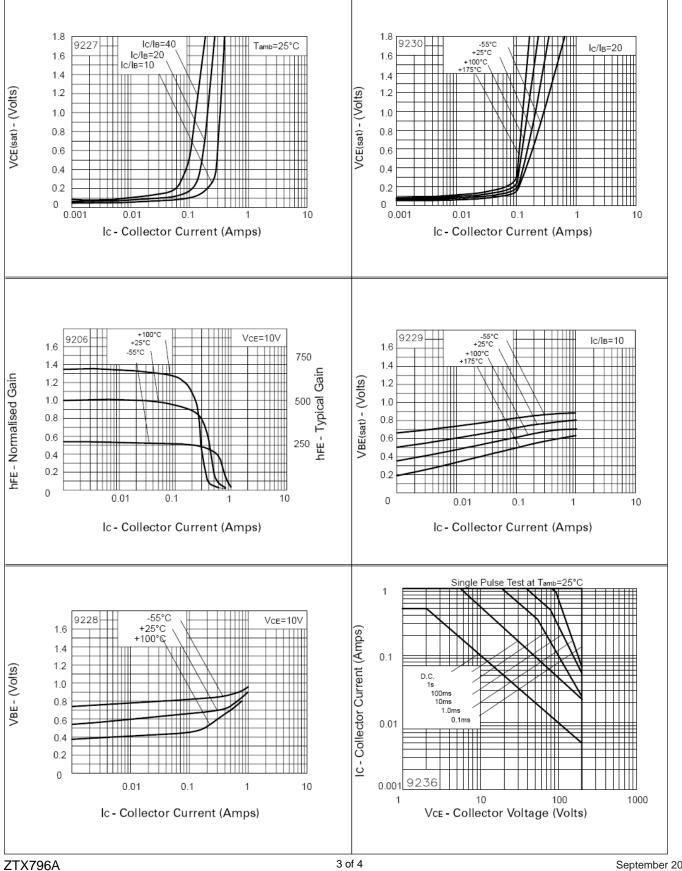








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# ZTX796A

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